Atty Docket No.: 278421US6	09-23-2005		
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		nagawa 6-chome, Shinagawa-ku	
Additional name(s) of conveying party(ies) attached? ☐ Yes	Tokyo, 141-0 ■ No Japan	ooi 78. ≣	
3. Nature of Conveyance:		00 <u>=</u>	
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☐ Security Agreement ☐ Change of Name		132	
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Execution Date: September 7, 2005	Additional name(s) and a	address(es) attached? Yes No	
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This document is being filed together with a new application	on		
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5. Name and address of party to whom correspondence	6. Total applications an	d natents involved: 1	
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PATENT REEL: 017002 FRAME: 0848

Docket Number:

ASSIGNMENT		
WHEREAS, I, as a below named inventor, residing at the ad- only one name is listed below) or a joint inventor (if plural names are listed be EDITING APPARATUS, EDITING METHOD, AND PROGRAM		
for which application for Letters Patent of the United States of America was excand address;	ecuted by me on the date indicated next to my name	
AND WHEREAS, Sony Corporation, a Japanese corporation Shinagawa-Ku, Tokyo, Japan (hereinafter referenced as ASSIGNEE) is desirous of said application disclosing the invention and in, to and under any Letters Pater therefor in the United States and in any and all foreign countries;	f acquiring all interest in, to and under said invention,	
NOW THEREFORE, in consideration of the sum of One Dollar the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joi hereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns interest in the said invention, said application, including any divisions and contract of the United States, and countries foreign thereto, which may be granted rights and/or convention rights under the International Convention for the Protection Relating to Patents, Designs and Industrial Models, and any other international adheres, and to any other benefits accruing or to accrue to me with respect to patents in the United States and countries foreign thereto, and I hereby authorize a said United States Letters Patent to said ASSIGNEE, as the assignee of the who	nt inventor as indicated below, by these presents do and legal representatives, the entire right, title and tinuations thereof, and in and to any and all Letters for said invention, and in and to any and all priority on of Industrial Property, Inter-American Convention agreements to which the United States of America the filing of applications for patents or securing of and request the Commissioner of Patents to issue the	
And I further agree to execute all necessary or desirable and lawful further or its designee, as ASSIGNEE or its successors, assigns and legal reand without further remuneration, in order to perfect title in said invention, mapplications and Letters Patent of the United States and countries foreign thereto	epresentatives may from time-to-time present to me nodifications, and improvements in said invention,	
And I further agree to properly execute and deliver and without further repapers for application for foreign patents, for filing subdivisions of said applications of any Letters Patent which may be granted for my aforesaid invention, a prepare at its own expense;	tion for patent, and or, for obtaining any reissue or	
And I further agree that ASSIGNEE will, upon its request, be provide relating to said application, said invention and said Letters Patent and legal equ accessible to me and will testify as to the same in any interference or litigation:	ivalents in foreign countries as may be known and	
And I hereby covenant that no assignment, sale, agreement or encumbra would conflict with this assignment and sale.	nce has been or will be made or entered into which	
And I hereby authorize and request my attorney(s) of record in this application in the spaces that follow: Serial Number:		
This assignment executed on the dates indicated below.		
Keizo INOUE		
Name of first or sole inventor	Execution date of U.S. Patent Application	
Tokyo, Japan		
Residence of first or sole inventor	200T	
	einber 7, 2005	
Signature of first or sole inventor	Date of this assignment	

RECORDED: 09/16/2005

PATENT REEL: 017002 FRAME: 0849